



TET ESTEL AS
ESTONIA

**October
2014**

**Series
T161-160**

Phase Control Stud Mounted Thyristor Type T161-160

Center amplifying gate
Low on-state and switching losses
Designed for traction and industrial applications

Maximum mean on-state current	I_{TAV}	160 A								
Maximum repetitive peak off-state and reverse voltage	U_{DRM}	800 ÷ 1800 V								
Turn-off time	t_q	100; 125; 160; 250 µs								
U _{DRM} , U _{RRM} , V	800	900	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	8	9	10	11	12	13	14	15	16	18
T _{vj} , °C	- 60 ÷ 125									

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	T161-160	Conditions
I _{TAV}	Mean on-state current	A	160 210	T _c =87 °C, T _c =70 °C 180° half-sine wave, 50 Hz
I _{TRMS}	RMS on-state current	A	251	T _c =87 °C
I _{TSM}	Surge on-state current	kA	4,5 5,0	T _{vj} =125°C T _{vj} =25°C
I ² t	Limiting load integral	kA ² s	101 125	T _{vj} =125°C T _{vj} =25°C
U _{DRM} , U _{RRM}	Repetitive peak off-state and reverse voltage	V	800÷1800	T _{j min} ≤T _{vj} ≤T _{jM} 180° half-sine wave, 50 Hz Gate open
U _{DSM} , U _{RSM}	Non-repetitive peak off-state and reverse voltage	V	900÷1900	T _{j min} ≤T _{vj} ≤T _{jM} 180° half-sine wave tp=10 ms, Single pulse Gate open
(d _i /dt) crit	Critical rate of rise of on-state current : non - repetitive repetitive	A/µs	250 125	T _{vj} =125°C ; U _d =0,67 U _{DRM} , Gate pulse : 10V, 5 Ω, 1µs rise time, 10 µs
U _{RGM}	Peak reverse gate voltage	V	5	T _{j min} ≤T _{vj} ≤T _{jM}
T _{stg}	Storage temperature	°C	-60÷80	
T _{vj}	Junction temperature	°C	-60÷125	

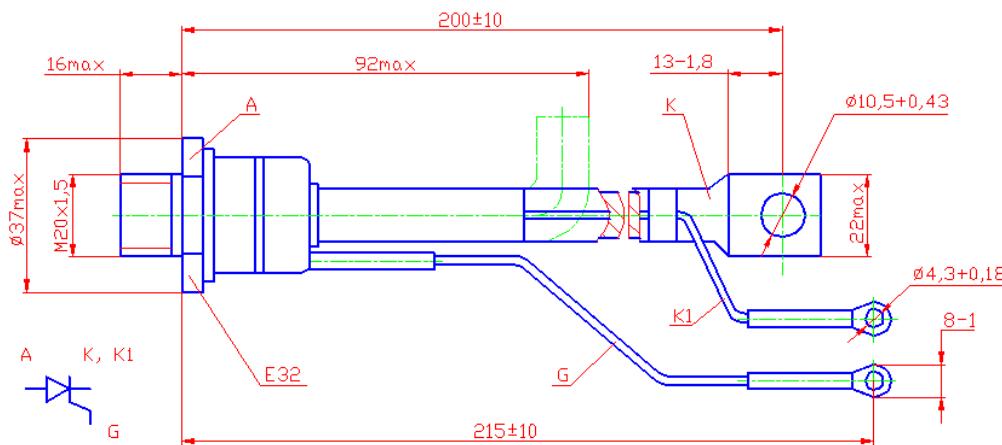
CHARACTERISTICS

U _{TM}	Peak on-state voltage	V	1,7	T _{vj} =25°C, I _{TM} =3,14 I _{TAV}
U _{T(TO)}	Threshold voltage	V	1,03	T _{vj} =125°C
R _T	On-state slope resistance	mΩ	1,38	1,57 I _{TAV} < I _T <4,71 I _{TAV}
I _{DRM} I _{RRM}	Repetitive peak off-state and reverse current	mA	20 20	T _{vj} =125°C, U _d =U _{DRM} U _r =U _{RRM}

CHARACTERISTICS				
Symbols and parameters		Units	T161-160	Conditions
I _L	Latching current	A	0,5	T _{VJ} =25°C, U _D =12V Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs
I _H	Holding current	A	0,25	T _{VJ} =25°C, U _D =12V, Gate open
U _{GT}	Gate trigger direct voltage	V	2,5 5,0	T _{VJ} =25°C, T _{VJ} =-60°C UD=12V
I _{GT}	Gate trigger direct current	A	0,3 0,85	T _{VJ} =25°C, T _{VJ} =-60°C
U _{GD}	Gate non-trigger direct voltage	V	0,25	T _{VJ} =125°C, UD = 0,67 U _{DRM} Direct gate current
I _{GD}	Gate non-trigger direct current	mA	10	
t _{gd}	Delay time	μs	1,6	T _{VJ} =25°C, UD=500V IT _M = 160 A
t _{gt}	Turn-on time	μs	3,2	Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs
t _q	Turn-off time	μs	100÷250	T _{VJ} =125°C, IT _M =160 A di _R /dt=10 A/μs, U _R =100V UD = 0,67 U _{DRM} du _D /dt=50 V/μs
Q _{rr}	Recovered charge	μC	600	T _{VJ} =125°C, IT _M =160 A dir/dt=10 A/μs, UR=100V
t _{rr}	Reverse recovery time	μs	20	
I _{RRM}	Peak reverse recovery current	A	60	
(dU _D /dt) _{crit}	Critical rate of rise of off-state voltage	V/μs	500 1000	T _{VJ} =125°C, UD = 0,67 U _{DRM} Gate open
R _{thjc}	Thermal resistance junction to case	°C/W	0,15	Direct current

ORDERING						
	T	161	160	16	7	4
	1	2	3	4	5	6

1. Phase control thyristor.
2. Design version.
3. Mean on-state current, A.
4. Voltage code (16=1600 V).
5. Critical rate of rise of off-state voltage ($6 \geq 500 \text{ V/}\mu\text{s}$, $7 \geq 1000 \text{ V/}\mu\text{s}$).
6. Group of turn-off time ($\text{du}_D/\text{dt} = 50 \text{ V/}\mu\text{s}$, $4 \leq 100 \mu\text{s}$, $X2 \leq 125 \mu\text{s}$; $3 \leq 160 \mu\text{s}$, $2 \leq 250 \mu\text{s}$).



Tightening torque : 25 ÷ 35 Nm. Weight : 250 grams.
Thyristors can be supplied in the packages with the framework of M16x1,5 in accordance to the customer.